FLASH-induced damage to various optical materials

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Layout

- Damage experiment @ FLASH
 - experimental setup
 - irradiation conditions
- Damage (post-mortem analysis)
 - Si bulk
 - a-C thin layer
 - SiC and B4C bulk
 - SiC multilayer
 - ScSi mulitlayer
- Damage (*pump-probe microscopy*)
- Transmission/Reflectivity
 - during the pulse
 - 1 color pump-probe
- Conclusions

Damage experiment @ FLASH Experimental setup



Damage experiment @ FLASH Experimental setup



Damage experiment @ FLASH Irradiation conditions

Wavelength [nm]	13.4 – 32.5	
	89 – 98	
Pulse duration [fs]	10 – 50	
	30 – 100	
Pulse energy [µJ]	0.1 - 20	
Spot diameter [µm]	20 – 30	
	15 – 100	
Fluence [mJ/cm ²]	1 - 5000	
Pulse number	1	
	10-100	

Damage "Post-mortem" analysis



Optical microscopy





AFM



X-Ray Diffraction

Si – bulk (11 pulses@89 nm)

F<4 mJ/cm²

F~40 mJ/cm²

F~70 mJ/cm²



50 um









Si – bulk (1pulse@32.5 nm)





X[µm]









a-C – thin layer on Si @89 nm

 Amorphous-carbon samples (a-C) consisted of 46 nm-thick a-C layers magnetron-sputterdeposited on a silicon wafer. The surface roughness of the a-C layers were less than 3 Å.





a-C – thin layer on Si @32.5 nm





SiC & B4C

- SiC slabs were fabricated using chemical-vapor deposition and had an average grain size of 7.5 mm. After polishing and prior to exposure, the surface roughness of the samples was analyzed using atomic-force microscopy (AFM). The root-means-square (RMS) roughness of the sample surface was 1.8 Å.
- B4C slabs were fabricated by hotpressing of B4C powder and had an average grain size of 5 mm. The polishing of the hot-pressed B4C produced numerous rip outs of B4C grains. A smooth surface was achieved in between the rip outs, with an RMS surface roughness of 5 Å.





SiC multilayer

The multilayer films consisted ulletof ten Si/C bilayers, sputterdeposited on a Si (100) wafer. In order to detect radiationinduced changes of the multilayer, we chose multilayer design that provided a narrow angular reflectivity peak at a reflection angle of 45° and a wavelength of 32 nm. This narrow bandwidth makes the multilayer very sensitive to any changes in the multilayer structure or the optical constants of its constituents





Damage thresholds [mJ/cm²]

λ = 89 nm		λ = 32.5 nm	
Si	< 4	Si	87 ± 45
a-C	<10	a-C	65 ± 30
		SiC	141 ± 70
		B ₄ C	197 ± 100
		CVD diamond	156 ± 75

Dynamic of damage processes 2 color pump & probe



Transmission/Reflectivity during the pulse

- 50 nm Si film
- 300 nm Al film
- SiO₂ monocrystal





Transmission/Reflectivity during the pulse





During the pulse



Reflectivity, optical constants unchanged Multilayer *d* spacing not changed by more than 0.3 nm



Transmission/Reflectivity pump-probe





- The optical response at 32.5 nm wavelength of the investigated materials (Si, SiO2 – bulk and Si, AI – thin foils) appears to be linear up to the maximum attainable intensities (≈ 1014 W/cm2) and deposited energy densities in excess of 100 eV per atom [publication in preparation].
- The multilayer performance does not degrade during the damaging pulse Initial results from one-colour pump-probe experiments in 2006 suggest that the optical properties of the multilayer do not change significantly from 10 fs up to 2 ps after excitation.
- First time-resolved reflectivity measurements in the visible range of solid surfaces (Si, GaAs) irradiated with FLASH have been investigated using picosecond optical imaging. Distinct differences in the material response are found in comparison to fs optical excitation. These differences are attributed to the increased penetration depth of the XUV-radiation and the absence of any absorption nonlinearities.
- Damage thresholds were obtained for a variety of inorganic materials in the wavelength range 13.5 nm 100 nm The threshold fluence for surface-damage is comparable to the fluence required for thermal melting. For larger fluences, the crater depths and morphology suggest that the craters are formed by ejection of (2-phase) molten material. For optical lasers such behavior is only known in the case of cw- and long-pulse irradiation.

Literature

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